

Title (en)

METHOD AND DEVICE FOR PRODUCING A METALLIC STRIP

Title (de)

VERFAHREN UND VORRICHTUNG ZUM HERSTELLEN EINES METALLISCHEN BANDES

Title (fr)

PROCÉDÉ ET DISPOSITIF DE FABRICATION D'UNE BANDE MÉTALLIQUE

Publication

**EP 4122615 C0 20231213 (DE)**

Application

**EP 22184469 A 20220712**

Priority

DE 102021207947 A 20210723

Abstract (en)

[origin: JP2023016726A] To provide a method for manufacturing a metal band material that rolls a band material from a slab 3 using a plurality of rolling stands in a rolling line, and connects individual partial slabs to be rolled from the individual partial slabs 3a and 3b by a slab joint device 4, which separates a part 5 of the partial slab 3a positioned in front in a rolling direction R and a part of the partial slab 3b positioned backward in the rolling direction in the slab joint device, and joins both of the slabs in a separation part 6, enables improved monitoring of a slab manufacturing process and can quickly react defects in a coarsely rolled product (slab or coarsely rolled material).SOLUTION: At least one of both of partial slab 3a and 3b is measured in a separation part 6 before joining after both of the partial slabs are separated.SELECTED DRAWING: Figure 2

IPC 8 full level

**B21B 15/00** (2006.01); **B21B 37/00** (2006.01); **B21B 38/00** (2006.01)

CPC (source: EP)

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